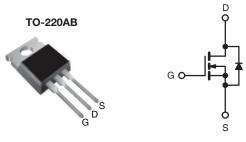




E Series Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	550			
R _{DS(on)} max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.184		
Q _g max. (nC)	92			
Q _{gs} (nC)	10			
Q _{gd} (nC)	19			
Configuration	Single			



N-Channel MOSFET

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Low gate charge (Q_a)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Computing
 - PC silver box / ATX power supplies
- Lighting
 - Two stage LED lighting
- Consumer electronics
- · Applications using hard switched topologies
 - Power factor correction (PFC)
 - Two switch forward converter
 - Flyback converter
- Switch mode power supplies (SMPS)

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free and Halogen-free	SiHP20N50E-GE3

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \degree C$, unless otherwise noted)					
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V _{DS}	500	v
Gate-Source Voltage			V _{GS}	± 30	v
Continuous Drain Current (T ₁ = 150 °C)	λ of 10 λ	T _C = 25 °C T _C = 100 °C	- I _D	19	
Continuous Drain Current $(1j = 150^{\circ} C)$	V _{GS} at 10 V	T _C = 100 °C		12	А
Pulsed Drain Current ^a			I _{DM}	42	
Linear Derating Factor				1.4	W/°C
Single Pulse Avalanche Energy ^b			E _{AS}	204	mJ
Maximum Power Dissipation			PD	179	W
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C
Drain-Source Voltage Slope $V_{DS} = 0 V to 80 \% V_{DS}$		dV/dt	70	1//22	
Reverse Diode dV/dt ^d			32	V/ns	
Soldering Recommendations (Peak Temperature) c for 10 s				300	°C

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 3.8 A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D$, dl/dt = 100 A/µs, starting T_J = 25 °C.

THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-	62	°C/W
Maximum Junction-to-Case (Drain)	R _{thJC}	-	0.7	0/10

S15-0278-Rev. B, 23-Feb-15

1 For technical questions, contact: <u>hvm@vishay.com</u> Document Number: 91633

Pb

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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		•		•		•	•
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} :	= 0 V, I _D = 250 μA	500	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.59	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μΑ	2.0	-	4.0	V
Octo Course Lockers			V _{GS} = ± 20 V	-	-	± 100	nA
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 30 V	-	-	± 1	μA
Zara Cata Valtaga Drain Current		V _{DS} =	= 500 V, V _{GS} = 0 V	-	-	1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 400 V	/, V _{GS} = 0 V, T _J = 125 °C	-	-	10	μA
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 10 A	-	0.160	0.184	Ω
Forward Transconductance	g fs	V _{DS}	= 30 V, I _D = 10 A	-	4.4	-	S
Dynamic		•		•	•	•	
Input Capacitance	C _{iss}		V _{GS} = 0 V,	-	1640	-	-
Output Capacitance	C _{oss}		$V_{DS} = 100 V,$	-	87	-	
Reverse Transfer Capacitance	C _{rss}		f = 1 MHz	-	6	-	
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	$V_{DS} = 0 V$ to 400 V, $V_{GS} = 0 V$		-	73	-	pF
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	222	-	1
Total Gate Charge	Qg			-	46	92	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	I _D = 10 A, V _{DS} = 400 V	-	10	-	nC
Gate-Drain Charge	Q _{gd}	1		-	19	-	
Turn-On Delay Time	t _{d(on)}	$V_{DD} = 400 \text{ V}, \text{ I}_{D} = 10 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	17	34	
Rise Time	t _r			-	27	54	ns
Turn-Off Delay Time	t _{d(off)}			-	48	96	
Fall Time	t _f		5	-	25	50	1
Gate Input Resistance	Rg	f = 1 MHz, open drain		-	0.83	-	Ω
Drain-Source Body Diode Characteristic	s	•		•	•	•	
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	19	
Pulsed Diode Forward Current	I _{SM}			-	-	42	A
Diode Forward Voltage	V _{SD}	$T_{J} = 25 \text{ °C}, I_{S} = 10 \text{ A}, V_{GS} = 0 \text{ V}$		-	-	1.2	V
Reverse Recovery Time	t _{rr}			-	293	-	ns
Reverse Recovery Charge	Q _{rr}	T _J = 25 °C, I _F = I _S = 10 A, dl/dt = 100 A/μs, V _R = 25 V		-	4.0	-	μC
Reverse Recovery Current	I _{RRM}			-	26	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

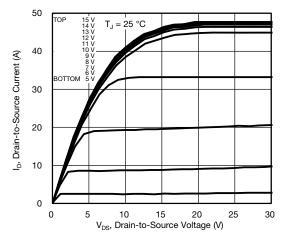


Fig. 1 - Typical Output Characteristics

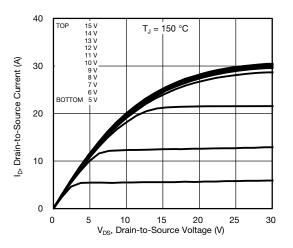


Fig. 2 - Typical Output Characteristics

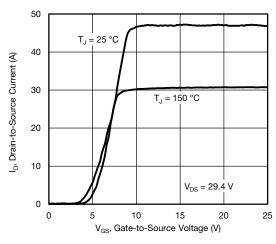


Fig. 3 - Typical Transfer Characteristics

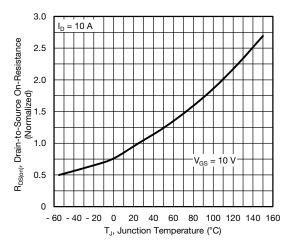


Fig. 4 - Normalized On-Resistance vs. Temperature

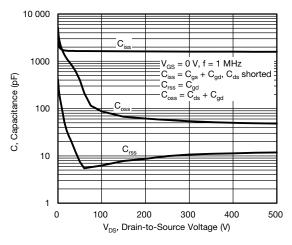


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

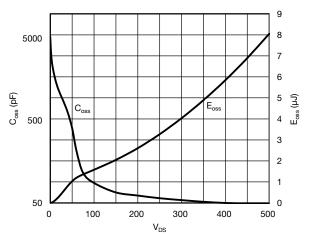


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

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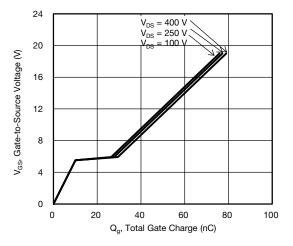


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

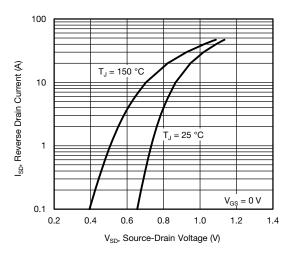


Fig. 8 - Typical Source-Drain Diode Forward Voltage

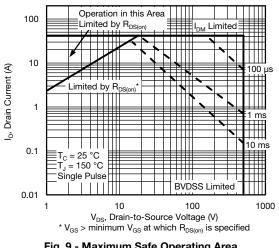


Fig. 9 - Maximum Safe Operating Area

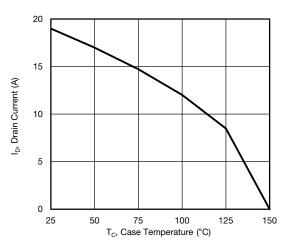


Fig. 10 - Maximum Drain Current vs. Case Temperature

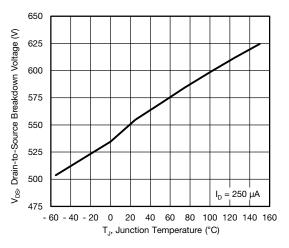


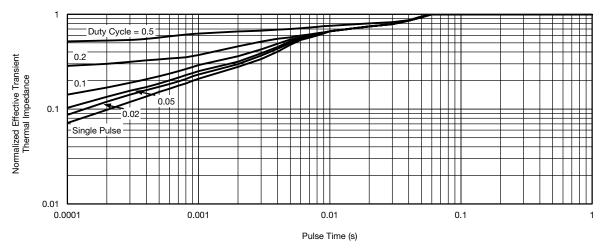
Fig. 11 - Temperature vs. Drain-to-Source Voltage

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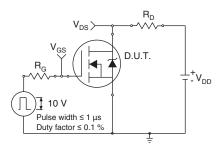


Fig. 13 - Switching Time Test Circuit

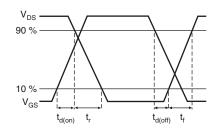


Fig. 14 - Switching Time Waveforms

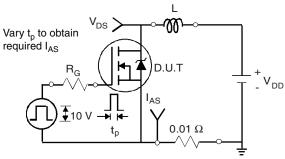


Fig. 15 - Unclamped Inductive Test Circuit

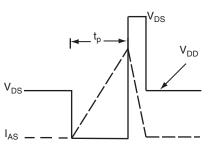


Fig. 16 - Unclamped Inductive Waveforms

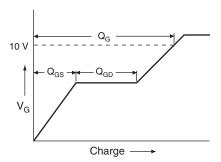


Fig. 17 - Basic Gate Charge Waveform

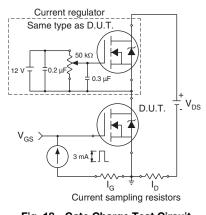


Fig. 18 - Gate Charge Test Circuit

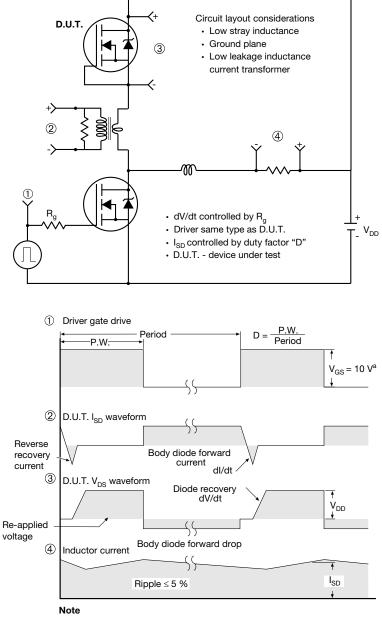
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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

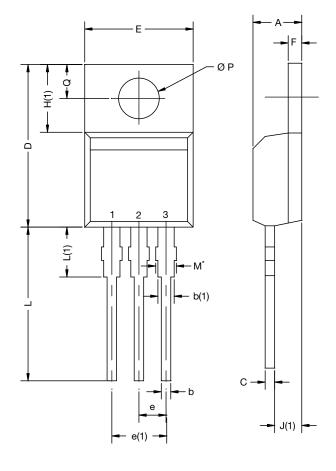
Fig. 19 - For N-Channel

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TO-220-1



DIM.	MILLIN	IETERS	INC	HES
DIIVI.	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
Е	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØΡ	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031				

Note

• $M^* = 0.052$ inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Package Picture				
AS	3E	Xi	'an	
		IRF 9510 744K AB		

Revison: 14-Dec-15

Document Number: 66542

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